

SPECIFICATION SHEET

SPECIFICATION SHEET NO.	Q0609- CRCR12JA75RS01
DATE	June. 9, 2023
REVISION	A0
DESCRIPTION	Thick Film Chip Resistors, 2512 (6432 Metric), CR12 Series, Dimension L6.40*W3.20*H0.60mm, 2 Terminations, Tolerance: ±5.0%, Resistance 75 ohm, Dissipation Max. 1W @ 70°C, Temperature Coefficient Rate (TCR) Max. ±100ppm/°C Operating Temp. Range -55°C ~+155°C Package in Tape/Reel, 4,000pcs/Reel RoHS/RoHS III compliant and HF
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	Aillen CR12JA75R
PART CODE	CRCR12JA75RS01

VENDOR APPROVE

Issued/Checked/Approved



DATE: June. 9, 2023

CUSTOMER APPROVE

DATE:

6/9/2023

THICK FILM CHIP RESISTORS CR12 SERIES

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer. The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.



MAIN FEATURE

- High power rating and compact size
- High reliability and stability
- Reduced size of final equipment
- RoHS compliant and Lead free products

APPLICATION

- Power supply / PDA
- Digital meter / PC
- Automotives / Battery charger
- DC-DC power converter

RFQ

[Request For Quotation](#)

PART CODE GUIDE

CRCR	12	J	A	75R	S01
1	2	3	4	5	6

1) **CRCR**: Product code for Thick Film Chip Resistors

2) **12**: Size Code, 2512 (6432 Metric), CR12 Series, Dimension L6.40*W3.20*H0.60mm,

3) **J**: Resistance Range Tolerance Code, P: Jumper; B: +/-0.1%; D: +/-0.5%; F: +/-1%; J: +/-5%

4) **A**: Package Code, A: 4Kpcs/7"Reel; B:5kpcs/7"Reel; C:10kpcs/7"Reel; M:15kpcs/7"Reel; D:10kpcs/10"Reel; E:20kpcs/10"Reel

5) **75R**: Resistance value code. 0R: 0ohm; R56: 0.56ohm; 18R: 18ohm; 20R: 20ohm; 22R: 22ohm; 75R: 75ohm; 100R: 100ohm;

750R: 750ohm; 1K:1Kohm; 1K87: 1.87Kohm; 4K7: 4.7Kohm; 10K: 10Kohm; 10K5: 10.5Kohm; 39K: 39 Kohm; 150K: 150Kohm; 820K:

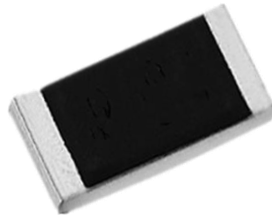
820Kohm; 1M: 1.0Mohm; 1M2: 1.2Mohm

6) **S01**: Internal control code, digits and letter; Blank: N/A

THICK FILM CHIP RESISTORS CR12 SERIES

DIMENSION (Unit: mm)

Image for reference

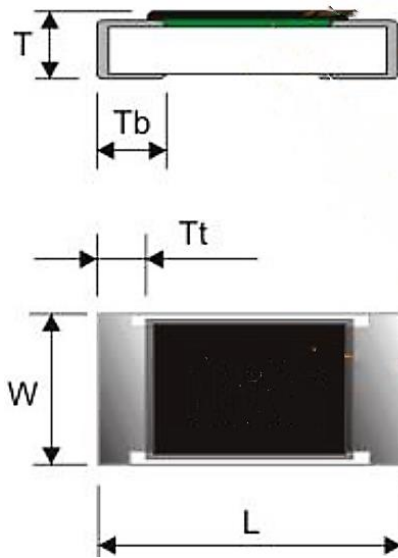


General Marking:

4-digits marking

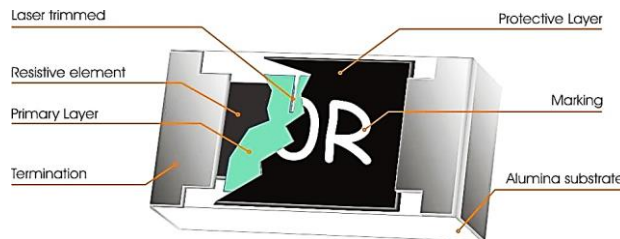
*Each resistor is marked with a four digits code on the protective coating to designate the nominal resistance value

CR12 series



Item	Dimension
L	6.40±0.20
W	3.20±0.20
T	0.60±0.10
T b	0.90±0.25
T t	0.65±0.25

Resistors Construction For Reference



Recommended Solder Pad



Item	Dimension
W	3.6~4.0
L	7.8~8.6
D	2.3~3.5

THICK FILM CHIP RESISTORS CR12 SERIES
GENERAL ELECTRONICAL CHARACTERISTICS

Item		Unit	Symbol	Characteristic	Condition
Product Name			CRCR	Thick Film Chip Resistors	
Size			12	CR12 Series, L6.40*W3.20*H0.60mm	
Resistance Range		Ω		75	
Resistance Tolerance		%	J	+/-5	
TCR	10Ω ≤ Rn ≤ 10M Ω	ppm/°C		≤±100	
	1Ω ≤ Rn ≤ 10 Ω			≤±200	
Max. Dissipation		W		1	@ Tamb=70°C
Operating Temperature		°C		-55 ~+155	
Max. Operation Voltage		V		250	@DC or RMS
Max. Overload Voltage		V		500	@DC or RMS

Note

1) This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"

2) Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

$$RCWV = \sqrt{\text{Rated Power} \times \text{Resistance Value}} \text{ or Max. RCWV listed above, whichever is lower.}$$

3. Max. Operation Current : So called RCWC (Rated Continuous Working Current) is determined by

4.
$$RCWC = \sqrt{\text{Rated Power} / \text{Resistance Value}}$$

Item	Unit	Symbol	Characteristic	Condition
Power Rating At 70°C	W		1	
Max. Resistance	mΩ		50	
Rated Current	A		4.5	
Peak Current	A		11	
Operating Temperature	°C		-55 ~+155	

THICK FILM CHIP RESISTORS CR12 SERIES

PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E24 & E96 series for resistors with a tolerance of $\pm 0.1\%$, $\pm 0.5\%$, $\pm 1\%$ & $\pm 5\%$. The values of the E24/E96 series are in accordance with "IEC publication 60063"

DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.1

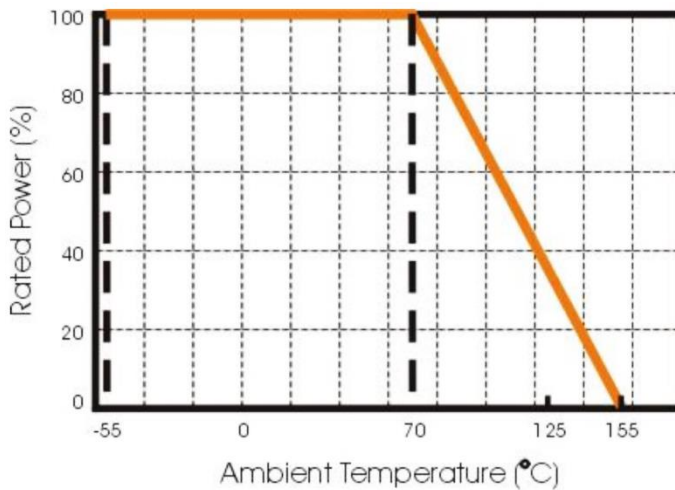


Fig 1 Maximum dissipation in percentage of rated power as a function of the ambient temperature for CR12

THICK FILM CHIP RESISTORS CR12 SERIES

REFLOW SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Resistors are tested for solderability at 235 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in below.

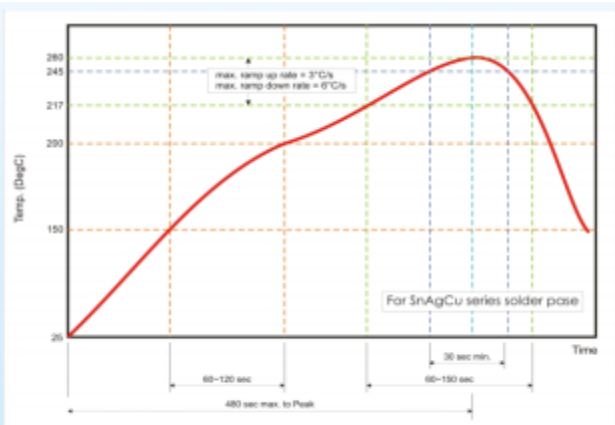


Fig. 1 Recommended IR reflow soldering profile for SMT process with SnAgCu series solder paste.

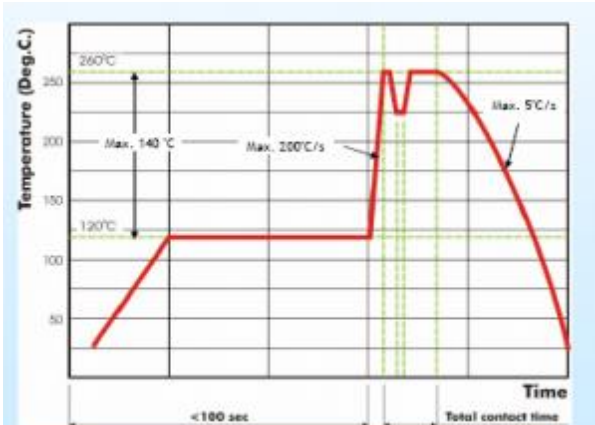


Fig. 2 Recommended wave soldering profile for SMT process with SnAgCu series solder.

THICK FILM CHIP RESISTORS CR12 SERIES
TEST AND REQUIREMENT (JIS C 5201-1 : 1998)

TEST	PROCEDURE / TEST METHOD	REQUIREMENT
DC resistance Clause 4.5	DC resistance values measured at the test voltages specified below : <10Ω@0.1V, <100Ω@0.3V, <1KΩ@1.0V, <10KΩ@3V, <100KΩ@10V, <1MΩ@25V, <10MΩ@30V	Within the specified tolerance
Temperature Coefficient of Resistance(T.C.R) Clause 4.8	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/}^\circ\text{C)}$ t1 : 20°C+5°C-1°C R1 : Resistance at reference temperature R2: Resistance at test temperature	Refer to “QUICK REFERENCE DATA”
Short time overload (S.T.O.L) Clause 4.13	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	Δ R/R max. ±(2%+0.1Ω)
Resistance to soldering heat(R.S.H) Clause 4.18	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260 ±5°C	Δ R/R max.±(1%+0.05Ω) No visible damage
Solderability Clause 4.17	Un-mounted chips completely immersed for 2±0.5second in a SAC solder bath at 235°C±5°C	Good tinning (>95% covered) No visible damage
Temperature cycling Clause 4.19	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30 minutes at +155°C±3°C, 2~3 minutes at 20°C+5°C-1°C, total 5 continuous cycles	Δ R/R max. ±(1%+0.05Ω) No visible damage
Load Life (Endurance) Clause 4.25	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off	Δ R/R max. ±(3%+0.1Ω)
Humidity Clause 4.24	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C±C2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	Δ R/R max. ±(3%+0.1Ω)

THICK FILM CHIP RESISTORS CR12 SERIES

TEST AND REQUIREMENT (JIS C 5201-1 : 1998)

TEST	PROCEDURE / TEST METHOD	REQUIREMENT
Bending strength Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 2 mm, once for 10 seconds.	$\Delta R/R$ max. $\pm(1\%+0.05\Omega)$
Adhesion Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations.
Insulation Resistance Clause 4.6	Apply the maximum overload voltage (DC) for 1 minute	$R \geq 10G\Omega$
Dielectric Withstand Voltage Clause 4.7	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover

TEST AND REQUIREMENTS(JISC 5201-1:1998)

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56 (rated temperature range : Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied :

Temperature: 15 °C to 35 °C.

Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

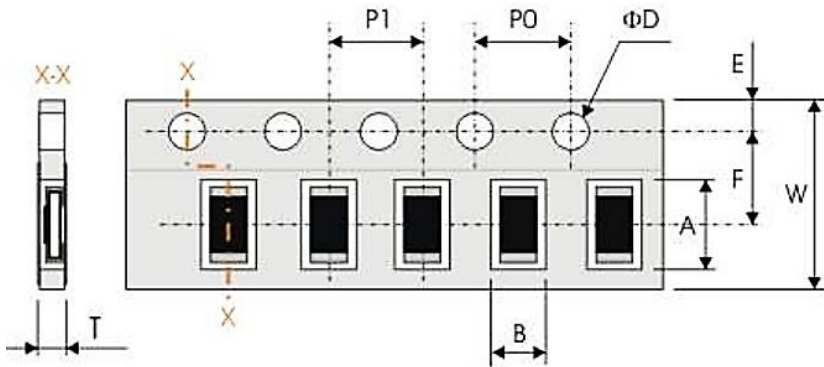
All soldering tests are performed with mildly activated flux.

THICK FILM CHIP RESISTORS CR12 SERIES
REEL DIMENSION (Unit: mm)

7": 4,000Ppcs/Reel



Code	Dimension 7"	Dimension 10"	Dimension 13"
A	178.0+/-2.0	254.0+/-2.0	330.0+/-2.0
B	60.0 +/-1.0	100 +/-1.0	100+/-1.0
C	13.0+/-0.20	13.0+/-0.20	13.0+/-0.20
D	12.4.0±1.00	14.0±0.20	14.0±0.20

TAPE DIMENSION (Unit: mm)


Code	Dimension
A	6.90±0.20
B	3.60±0.20
W	12.00±0.30
F	5.50±0.10
E	1.75±0.10
P 1	4.00±0.10
P0	4.00±0.10
ΦD	1.50+0.10/-0.00
T	1.2 Max.

TAPING QUANTITY AND TAPE MATERIAL

Tape	Paper Tape						Embossed Tape	Bulk Cassette
	4 mm Pitch			2 mm Pitch			4 mm Pitch	
Reel Size	7"	10"	13"	7"	10"	13"	7"	
CR12	-	-	-	4000	8000	16000	-	-

THICK FILM CHIP RESISTORS CR12 SERIES

PERFORMANCE OF TAPING

Strength of Carrier Tape and Top Cover Tape

Carrier Tape: When a tensile force 1.02kgf is applied in the direction of unreeling the tape, the tape shall withstand this force. Top cover Tape: When a tensile force 1.02kgf is applied to the tape, the tape shall withstand this force.

Peel Force of Top Cover Tape

Unless otherwise specified, the peel force of top cover tape shall be 10.2 to 71.4 g f when the top cover tape is pulled at a speed of 300mm/min with the angle between the taped during peel and the direction of unreeling maintained at 165 to 180° as illustrated in Fig.



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